

L Number	Hits	Search Text	DB	Time stamp
-	3	359/350.ccls. and 385/14,88-94.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 14:32
-	138	(385/14,88-94.ccls. or 359/350.ccls.) and ((infrared or infra-red) near5 (module or apparatus or device))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/05 15:27
-	1087	385/92,94.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 14:34
-	185	385/92,94.ccls. and substrate and (light or optic or optical) and mold\$7	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 14:34
-	420	385/92,94.ccls. and substrate and (light or optic or optical)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 14:34
-	351	gold and (mold\$5 near4 resin\$6) and substrate and emit\$8 and receiv\$7	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 16:32
-	326	(gold and (mold\$5 near4 resin\$6) and substrate and emit\$8 and receiv\$7 ) and (seal\$8 or cover\$6 or protect\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 16:33
-	155	((gold and (mold\$5 near4 resin\$6) and substrate and emit\$8 and receiv\$7 ) and (seal\$8 or cover\$6 or protect\$6)) and (housing or module)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:18
-	1826	(die near5 bond\$8 near4 pad\$6) and substrate and gold	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:31
-	687	((die near5 bond\$8 near4 pad\$6) and substrate and gold) and (module or housing)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:20
-	87	((die near5 bond\$8 near4 pad\$6) and substrate and gold) and (module or housing)) and emit\$7	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:20
-	2	((die near5 bond\$8 near4 pad\$6) near9 (mount\$7 near4 (emit\$8 or element or receiv\$6))) same gold	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:33
-	56	shimonaka-atsushi.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/04 17:37
-	6783	385/14,88-94.ccls. or 359/154,350.ccls. or 398/140,164.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/05 15:28
-	1775	(385/14,88-94.ccls. or 359/154,350.ccls. or 398/140,164.ccls.) and substrate and (transmi\$7 or emit\$7) and receiv\$8	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/05 15:47
-	103	((385/14,88-94.ccls. or 359/154,350.ccls. or 398/140,164.ccls.) and substrate and (transmi\$7 or emit\$7) and receiv\$8) and (mold\$8 near4 resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/05 15:47
-	135	(die near3 bond\$7 near4 pad) and (gold near3 plat\$7) and (transmi\$7 or emit\$7)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/05 16:16

-	16	(US-6473300-\$ or US-4599537-\$ or US-6208791-\$ or US-6031292-\$ or US-6318908-\$ or US-6170996-\$ or US-6213650-\$ or US-6530698-\$ or US-5546489-\$ or US-6548328-\$ or US-6332720-\$ or US-6435734-\$).did. or (US-20020141711-\$ or US-20020154667-\$ or US-20020126356-\$ or US-20020037143-\$).did.	USPAT; US-PGPUB	2003/06/05 17:03
-	6	((US-6473300-\$ or US-4599537-\$ or US-6208791-\$ or US-6031292-\$ or US-6318908-\$ or US-6170996-\$ or US-6213650-\$ or US-6530698-\$ or US-5546489-\$ or US-6548328-\$ or US-6332720-\$ or US-6435734-\$).did. or (US-20020141711-\$ or US-20020154667-\$ or US-20020126356-\$ or US-20020037143-\$).did.) and shield\$7	USPAT; US-PGPUB	2003/06/05 17:03